



Application Data Sheet

Application Information

Application number:: 10618933
Filing Date:: 07/14/03
Application Type:: Regular
Subject Matter:: Utility
Title:: Semiconductor multipackage module including
processor and memory package assemblies
Attorney Docket Number:: CPAC 1041-2
Suggested Drawing Figure::
Total Drawing Sheets::
Small Entity?:: No

Applicant Information

Applicant Authority Type: Inventor
Primary Citizenship Country: US
Status: Full Capacity
Given Name: Marcos
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State or Province of Residence: CA
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Correspondence Information

Correspondence Customer Number:: 22470

Representative Information

Representative Customer Number::	22470	
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Domestic Priority Information

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This application	An application claiming the benefit under 35 USC 119 (e)	60460541	June <u>April</u> 4, 2003

Assignee Information

Assignee name:: ChipPAC, Inc
Street of mailing address:: 47400 Kato Road
City of mailing address:: Fremont
State or Province of mailing address:: CA
Country of mailing address:: US
Postal or Zip Code of mailing address:: 94538